## innodisk

# M.2 ((P80))

## **3TG6-P Series**

Customer:	
Customer	
Part	
Number:	
Innodisk	
Part	
Number:	
Innodisk	
Model Name:	
Date:	

Innodisk	Customer
Approver	Approver

Total Solution For Industrial Flash Storage

#### Features:

- PCIe Gen.3 x 4, NVMe SSD
- Innodisk 3D TLC NAND
- M.2 2280-D2-M
- Standard & Wide-temperature
- iPowerguard
- iDataguard
- Dynamic Thermal Management
- Hybrid Write

#### **Performance:**

- Sequential Read up to 3,450 MB/s
- Sequential Write up to 2,600 MB/s

#### **Power Requirements:**

Input Voltage:	3.3V±5%
Max Operating Wattage (R/W):	6.8W
Idle Wattage:	1.3W

#### **Reliability:**

Capacity	TBW	DWPD
128GB	168	1.2
256GB	422	1.4
512GB	766	1.4
1TB	1793	1.6
2TB	4162	1.9

Data Retention	10 Years
Warranty	3 Years

For warranty details, please refer to:

https://www.innodisk.com/en/support\_and\_service/warranty

## **REVISION HISTORY**

Revision	Description	Date
V1.0	First release	Apr., 2021
V1.1	Revise PN rule info.	Sep., 2021
V1.2	Update Reliability info.	Jan., 2022
V1.3	Remove 2TB info.	Mar., 2022
V1.4	Update 112 Layers info.	May, 2022
V1.5	Revise TBW table description	Jun., 2022
V1.6	Revise Reliability info.	Jul., 2022
V1.7	Update 96 Layers, 112 Layers performance	Nov., 2022
V1.8	Update 112 Layers performance	Dec., 2022
V1.9	Revise Pin Assignment	Oct., 2023



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## **1. Product Overview**

#### 1.1 Introduction of Innodisk M.2 (P80) 3TG6-P

Innodisk M.2 (P80) 3TG6-P is an NVM Express SSD designed as the standard M.2 form factor with PCIe interface and 3D TLC NAND Flash. M.2 (P80)3TG6-P supports PCIe Gen III x4, and it is compliant with NVMe 1.3 providing excellent performance. M.2 (P80) 3TG6-P with heat-spreading design dissipate heat generating from IC making SSD perform more steady. M.2 (P80) 3TG6-P have Die RAID protection to reduce bad blocks happening and optimize data integrity. In addition, 3TG6-P series adopt hybrid mode which enables SLC Cache up to 3% of total user capacity followed by TLC direct write to strike balance between burst performance and steady overall stability.

Innodisk M.2 (P80) 3TG6-P provides ultra-speed and high IOPS and offers maximum capacity up to 2TB, making the SSD optimal for server and heavy data workload applications.

#### CAUTION TRIM must be enabled.

TRIM enables SSD's controller to skip invalid data instead of moving. It can free up significant amount of resources, extends the lifespan of SSD by reducing erase, and write cycles on the SSD. Innodisk's handling of garbage collection along with TRIM command improves write performance on SSDs.

#### **1.2 Product View and Models**

Innodisk M.2 (P80) 3TG6-P is available in follow capacities within 3D TLC flash ICs.

M.2 (P80) 3TG6-P 128GB M.2 (P80) 3TG6-P 256GB M.2 (P80) 3TG6-P 512GB M.2 (P80) 3TG6-P 1TB M.2 (P80) 3TG6-P 2TB



Figure 1: Innodisk M.2 (P80) 3TG6-P (Standard)



Figure 2: Innodisk M.2 (P80) 3TG6-P (Wide Temperature)



#### **PCIe Interface**

Innodisk M.2 (P80) 3TG6-P supports PCIe Gen III interface and compliant with NVMe 1.3. M.2 (P80) 3TG6-P can work under PCIe Gen 1, Gen 2 and Gen 3.

Most of operating system includes NVMe in-box driver now. For more information about the driver support in each OS, please visit <u>https://nvmexpress.org/drivers/</u>.



## 2. Product Specifications

#### 2.1 Capacity and Device Parameters

M.2 (P80) 3TG6-P device parameters are shown in Table 1.

Capacity	LBA	User Capacity(MB)
128GB	234441648	114473
256GB	468862128	228937
512GB	937703088	457863
1TB	1875385008	915715
2TB	3750748848	1831420

#### **Table 1: Device parameters**

#### **2.2 Performance**

Burst Transfer Rate: 4 GB/s

Table 2: Performance - 112 Layers 3D TLC

Capacity	Unit	128GB	256GB	512GB	1TB (1CE)	1TB (2CE)	2ТВ
Sequential** Read (Q32T1)	MB/s	820	1,450	2,300	2,300	3,400	3,450
Sequential** Write (Q32T1)		520	1,050	2,100	1,900	2,550	2,550
Sustained Sequential Read (Avg.)***		690	1,150	1,300	1,250	1,500	1,450
Sustained Sequential Write (Avg.)***		100	210	420	380	800	710
4KB Random** Read (Q8T8)	IOPS -	41,000	82,000	159,000	149,000	291,000	272,000
4KB Random** Write (Q8T8)		36,000	180,000	493,000	470,000	536,000	536,000

Note: \* Performance results are measured in Room Temperature with Out-of-Box devices and may vary depending on overall system setup. In addition, 3TG6-P series adopt hybrid mode which enables SLC Cache followed by TLC direct write to strike balance between burst performance and steady overall stability.

Note: \*\* Performance results are based on CrystalDiskMark 6.0.2 with file size 1000MB. Unit of 4KB items is I.O.P.S.

Note: \*\*\* Performance results are based on AIDA 64 v5.98 with block size 1MB of Linear Read & Write Test Item.



Capacity	Unit	128GB	256GB	512GB	1TB	2ТВ
Sequential**		840	1,500	2,300	3,250	3,000
Read (Q32T1)	MB/s	040	1,500	2,500	5,250	5,000
Sequential**		210	450	890	1 750	2 600
Write (Q32T1)		210	450	890	1,750	2,600
Sustained Sequential		670	1 100	1 250	1 500	1 500
Read (Avg.)***		670	1,100	1,250	1,500	1,500
Sustained Sequential		60	120	250	510	1,050
Write (Avg.)***		00	120	250	510	1,050
4KB Random**		41.000	85,000	164,000	301,000	461,000
Read (Q8T8)	41,000 IOPS		83,000	104,000	501,000	401,000
4KB Random**	1053	F2 000	111 000	220.000	420.000	542 000
Write (Q8T8)		53,000	111,000	220,000	430,000	543,000

Table 3: Performance - 96 Layers 3D TLC

Note: \* Performance results are measured in Room Temperature with Out-of-Box devices and may vary depending on overall system setup. In addition, 3TG6-P series adopt hybrid mode which enables SLC Cache followed by TLC direct write to strike balance between burst performance and steady overall stability.

Note: \*\* Performance results are based on CrystalDiskMark 6.0.2 with file size 1000MB. Unit of 4KB items is I.O.P.S.

Note: \*\*\* Performance results are based on AIDA 64 v5.98 with block size 1MB of Linear Read & Write Test Item.

#### 2.3 Electrical Specifications

#### 2.3.1 Power Requirement

#### Table 4: Innodisk M.2 (P80) 3TG6-P Power Requirement

Item	Symbol	Rating	Unit
Input voltage	VIN	+3.3 DC +- 5%	V

#### 2.3.2 Power Consumption

Table 5: T	ypical	Power	Consumption
------------	--------	-------	-------------

Mode	Power Consumption (W)
Read	6.3
Write	6.8
Idle	1.3

Target: 2TB M.2 (P80) 3TG6-P

Note: Current results may vary depending on system components and power circuit design

Please refer to the test report for other capacities

#### 2.4 Environmental Specifications

#### 2.4.1 Temperature Ranges

#### Table 6: Temperature range for M.2 (P80) 3TG6-P

Temperature	Range		
Operating	Standard Grade: 0°C to +70°C Industrial Grade: -40°C to +85°C		
Storage	-40°C to +85°C SOP		

#### 2.4.2 Humidity

Relative Humidity: 10-95%, non-condensing

#### 2.4.3 Shock and Vibration

#### Table 7: Shock/Vibration Testing for M.2 (P80) 3TG6-P

Reliability	Test Conditions	<b>Reference Standards</b>
Vibration	7 Hz to 2K Hz, 20G, 3 axes	IEC 60068-2-6
Mechanical Shock	Duration: 0.5ms, 1500 G, 3 axes	IEC 60068-2-27

#### 2.4.4 Mean Time between Failures (MTBF)

Table 7 summarizes the MTBF prediction results for various M.2 (P80) 3TG6-P configurations. The analysis was performed using a RAM Commander<sup>™</sup> failure rate prediction.

- **Failure Rate**: The total number of failures within an item population, divided by the total number of life units expended by that population, during a particular measurement interval under stated condition.
- **Mean Time between Failures (MTBF)**: A basic measure of reliability for repairable items: The mean number of life units during which all parts of the item perform within their specified limits, during a particular measurement interval under stated conditions.

Table 8: M.2 (P80) 3TG6-P MTBF

Product	Condition	MTBF (Hours)
Innodisk M.2 (P80) 3TG6-P	Telcordia SR-332 GB, 25°C	>3,000,000

#### 2.5 CE and FCC Compatibility

M.2 (P80) 3TG6-P conforms to CE and FCC requirements.

#### **2.6 RoHS Compliance**

M.2 (P80) 3TG6-P is fully compliant with RoHS directive.



#### 2.7 Reliability

#### Table 9: M.2 (P80) 3TG6-P TBW

Parameter	Value			
Flash endurance	3,000 P/E cycles			
Error Correct Code	Support(LDPC)			
Data Retention	Under 40°C:			
	10 Years at initial N	AND Status ; 1 Year at NAND Life End		
TBW* (Total Bytes Written) Unit: TB				
Capacity	Sequential workload	Client workload		
128GB	340	168		
256GB	680	422		
512GB	1363	766		
1TB	2727	1793		
2TB	5454	4162		
	·			

\* Note:

1. Sequential: Mainly sequential write are estimated by PassMark Burnin Test v8.1 pro.

2. Client: Follow JESD218 Test method and JESD219A Workload, tested by ULINK. (The capacity lower than 64GB client workload is not specified in JEDEC219A, the values are estimated.)

3. Based on out-of-box performance.

#### 2.8 Transfer Mode

M.2 (P80) 3TG6-P support following transfer mode: PCIe Gen III 4 GB/s

PCIe Gen II 2 GB/s

PCIe Gen I 1 GB/s

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#### 2.9 Pin Assignment

Innodisk M.2 (P80) 3TG6-P follows standard M.2 spec, socket 3, key M PCIe-based SSD pinout. See Table 10 for M.2 (P80) 3TG6-P pin assignment.

Signal Name	Pin #	Pin #	Signal Name
		75	GND
3.3V	74	73	GND
3.3V	72	71	GND
3.3V	70	69	NC
NC	68	67	NC
Notch	66	65	Notch
Notch	64	63	Notch
Notch	62	61	Notch
Notch	60	59	Notch
Reserved for MFG_CLOCK	58		
Reserved for MFG_DATA	56	57	GND
NC	54	55	REFCLKp
CLKREQ# (I/O)(0/3.3V)	52	53	REFCLKn
PERST# (I)(0/3.3V)	50	51	GND
NC	48	49	PERp0
NC	46	47	PERn0
ALERT	44	45	GND
NC(reserved for	42	43	DETro
SMB_DATA)(I/O)(O/1.8V)	42	43	PETp0
NC(reserved for SMB_CLK)	40	41	PETn0
NC	38	39	GND
NC	36	37	PERp1
NC	34	35	PERn1
NC	32	33	GND
NC	30	31	PETp1
NC	28	29	PETn1
NC	26	27	GND
NC	24	25	PERp2
NC	22	23	PERn2
NC	20	21	GND
3.3V	18	19	PETp2
3.3V	16	17	PETn2
3.3V	14	15	GND

Table 10: Innodisk M.2 (P80) 3TG6-P Pin Assignment

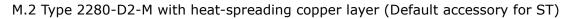
3.3V	12	13	PERp3
LED1#(OD)	10	11	PERn3
NC	8	9	GND
NC	6	7	PETp3
3.3V	4	5	PETn3
3.3V	2	3	GND
		1	GND



Table 11: Innodisk M.2 (P80) 3TG6-P LED indicator

LED C	Color	Function	
Green		Power on	
		Access	

#### 2.10 Mechanical Dimensions



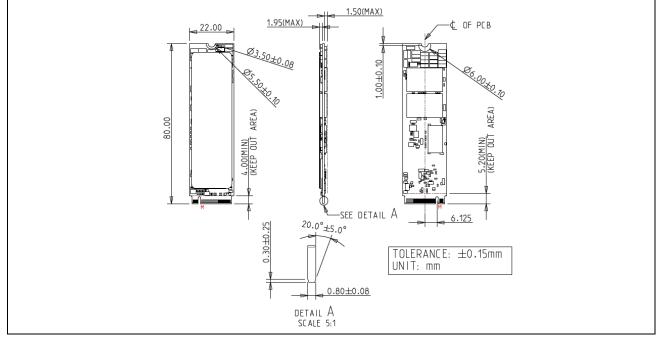


Figure 3: Innodisk M.2 (P80) 3TG6-P with heat-spreading copper layer diagram

M.2 Type 2280-D2-M with heatsink	(Default accessory for WT)
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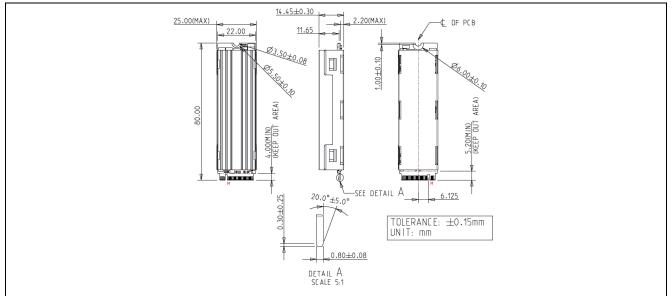


Figure 4: Innodisk M.2 (P80) 3TG6-P with heatsink diagram

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#### M.2 Type 2280-D2-M

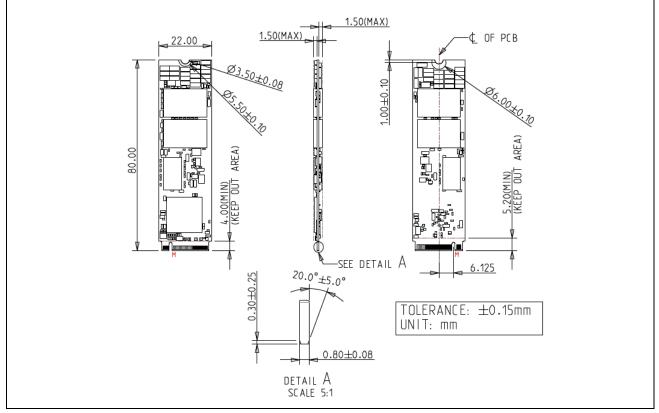


Figure 5: Innodisk M.2 (P80) 3TG6-P

#### 2.11 Assembly Weight

An Innodisk M.2 (P80) 3TG6-P within NAND flash ICs, 128GB's weight is 7 grams approximately.

#### 2.12 Seek Time

Innodisk M.2 (P80) 3TG6-P is not a magnetic rotating design. There is no seek or rotational latency required.

#### 2.13 NAND Flash Memory

Innodisk M.2 (P80) 3TG6-P uses 3D TLC NAND flash memory, which is non-volatility, high reliability and high speed memory storage.



## 3. Theory of Operation

#### 3.1 Overview

Figure 6 shows the operation of Innodisk M.2 (P80) 3TG6-P from the system level, including the major hardware blocks.

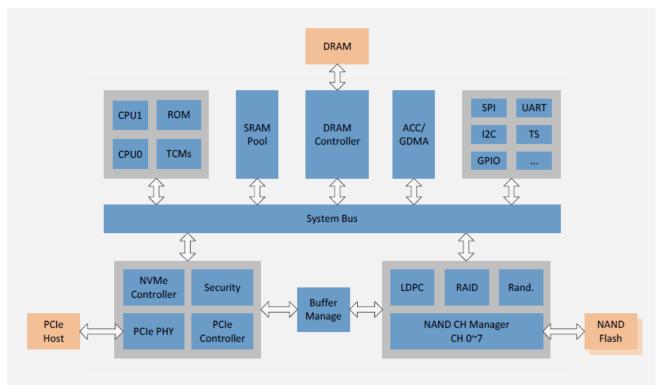


Figure 6: Innodisk M.2 (P80) 3TG6-P Block Diagram

Innodisk M.2 (P80) 3TG6-P integrates a PCIe Gen III x4 controller and NAND flash memories. Communication with the host occurs through the host interface, using the standard NVM protocol. Communication with the flash device(s) occurs through the flash interface.

#### 3.2 PCIe Gen III x4 Controller

Innodisk M.2 (P80) 3TG6-P is a PCIe Gen IIIx4 controller is compliant with NVMe 1.3, up to 32.0Gbps transfer speed. Also it is compliant with PCIe Gen 1, Gen 2 and Gen 3 specification. The controller supports up to 8 channels for flash interface.



#### **3.3 Error Detection and Correction**

Innodisk M.2 (P80) 3TG6-P is designed with hardware LDPC ECC engine with hard-decision and soft-decision decoding. Low-density parity-check (LDPC) codes have excellent error correcting performance close to the Shannon limit when decoded with the belief-propagation (BP) algorithm using soft-decision information.

#### 3.4 Wear-Leveling

Flash memory can be erased within a limited number of times. This number is called the **erase cycle limit** or **write endurance limit** and is defined by the flash array vendor. The erase cycle limit applies to each individual erase block in the flash device.

Innodisk M.2 (P80) 3TG6-P uses a combination of two types of wear leveling- dynamic and static wear leveling- to distribute write cycling across an SSD and balance erase count of each block, thereby extending flash lifetime.

#### 3.5 Bad Blocks Management

Bad Blocks are blocks that contain one or more invalid bits whose reliability are not guaranteed. The Bad Blocks may be presented while the SSD is shipped, or may develop during the life time of the SSD. When the Bad Blocks is detected, it will be flagged, and not be used anymore. The SSD implement Bad Blocks management, Bad Blocks replacement, Error Correct Code to avoid data error occurred. The functions will be enabled automatically to transfer data from Bad Blocks to spare blocks, and correct error bit.

#### 3.6 iData Guard

Innodisk's iData Guard is a comprehensive data protection mechanism that functions before and after a sudden power outage to the SSD. Low-power detection terminates data writing before an abnormal power-off, while table-remapping after power-on deletes corrupt data and maintains data integrity. Innodisk's iData Guard provides effective power cycling management, preventing data stored in flash from degrading with use.

#### 3.7 Garbage Collection/TRIM

Garbage collection and TRIM technology is used to maintain data consistency and perform continual data cleansing on SSDs. It runs as a background process, freeing up valuable controller resources while sorting good data into available blocks, and deleting bad blocks. It also significantly reduces write operations to the drive, thereby increasing the SSD's speed and lifespan.



#### **3.8 Thermal Management**

M.2 (P80) 3TG6-P has built-in thermal sensor which can detect environment temperature of SSD. In the meantime, firmware will monitor the thermal sensor to prevent any failure of overheating. During extreme temperature, firmware will adjust the data transfer behavior to maintain the SSD's reliable operation.

#### 3.9 iPower Guard

iPower Guard technology is a set of preventive measures that protect the SSD in an unstable power supply environment. This comprehensive package comprises safeguards for startup and shutdown to maintain device performance and ensure data integrity.

#### 3.10 Die RAID

Die RAID is a controller function which leveraged user capacity to back up the data in NAND flash. Die RAID supported can ensure the user data in the NAND Flash more consistent in certain scenario. Innodisk M.2 (P80) 3TG6-P series is default enable the Die RAID function for the industrial application.

#### 3.11 SLC Cache

3TG6-P series adopt hybrid mode which enables SLC Cache up to 3% of total user capacity followed by TLC direct write to strike balance between burst performance and steady overall stability. The SLC Cache buffer size are defined as table below.

Capacity	128GB	256GB	512GB	1TB	2ТВ		
SLC cache (GB)	3.84	7.68	15.36	30.72	61.44		
SLC cache (%)	3	3	3	3	3		

Table 12: M.2 (P80) 3TG6-P SLC cache



## 4. Installation Requirements

#### 4.1 M.2 (P80) 3TG6-P Pin Directions

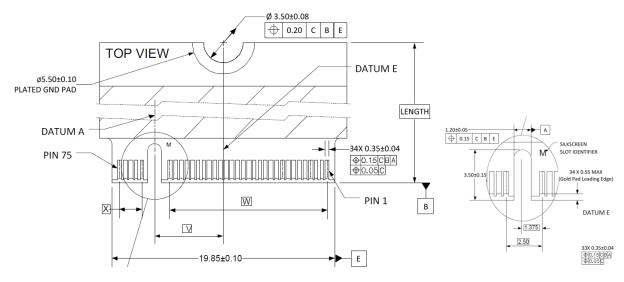


Figure 7: Signal Segment and Power Segment

#### 4.2 Electrical Connections for M.2 (P80) 3TG6-P

M.2 interconnect is based on a 75 position Edge Card connector. The 75 position connector is intended to be keyed so as to distinguish between families of host interfaces and the various Sockets used in general Platforms. M.2 (P80) 3TG6-P is compliant with M.2 Socket 3 key M. M.2 (P80) 3TG6-P is compatible with host connector H3.2 or H4.2.

#### 4.3 Device Drive

M.2 (P80) 3TG6-P is compliant with NVMe 1.3. Both Operation System and BIOS should include NVMe driver to compatible with NVMe device. Nowadays, most of OS includes NVMe in-box driver now. For more information about the driver support in each OS, please visit the website <u>https://nvmexpress.org/drivers/</u>. For BIOS NVMe driver support please contact with motherboard manufacturers.



## **5. SMART / Health Information**

This log page is used to provide SMART and general health information. The information provided is over the life of the controller and is retained across power cycles. More details about Set Features command; please refer to NVM Express 1.3

#### 5.1 Get Log Page(Log Identifier 02h)

Innodisk 3TG6-P series SMART / Health Information Log are listed in following table.

Bytes	Description										
0	Critical Warning: This field indicates critical warnings for the state of the										
	controller. Each bi	t corresponds to a critical warning type; multiple bits may be									
	set. If a bit is clea	red to $0'$ , then that critical warning does not apply. Critical									
	warnings may res	ult in an asynchronous event notification to the host. Bits in									
	this field represen	t the current associated state and are not persistent.									
	Bit	Definition									
	00	If set to `1', then the available spare space has fallen below the threshold.									
	01	If set to '1', then a temperature is above an over temperature threshold or below an under									
	02	If set to `1', then the NVM subsystem reliability has been degraded due to significant media related									
	03	If set to `1', then the media has been placed in read only mode.									
	04	If set to `1', then the volatile memory backup device has failed. This field is only valid if the									
	07:05	Reserved									
2:1	<b>Composite Temperature:</b> Contains a value corresponding to a temperature in degrees Kelvin that represents the current composite temperature of the										
	controller and nan	nespace(s) associated with that controller. The manner in									
	which this value is	s computed is implementation specific and may not represent									
	the actual temper	ature of any physical point in the NVM subsystem. The value of									

#### Table 13: Get Log Page – SMART / Health Information Log

M.2 (P80) 3TG6-P
this field may be used to trigger an asynchronous event.
Warning and critical overheating composite temperature threshold values are
reported by the WCTEMP and CCTEMP fields in the Identify Controller data
structure.
Available Spare: Contains a normalized percentage (0 to 100%) of the
remaining spare capacity available.
Available Spare Threshold: When the Available Spare falls below the
threshold indicated in this field, an asynchronous event completion may occur.
The value is indicated as a normalized percentage (0 to 100%).
Percentage Used: Contains a vendor specific estimate of the percentage of
NVM subsystem life used based on the actual usage and the manufacturer's
prediction of NVM life. A value of 100 indicates that the estimated endurance of
the NVM in the NVM subsystem has been consumed, but may not indicate an
NVM subsystem failure. The value is allowed to exceed 100. Percentages greater
than 254 shall be represented as 255. This value shall be updated once per
power-on hour (when the controller is not in a sleep state).
power-on hour (when the controller is not in a sleep state).
Refer to the JEDEC JESD218A standard for SSD device life and endurance
measurement techniques.
Reserved
Data Units Read: Contains the number of 512 byte data units the host has
read from the controller; this value does not include metadata. This value is
reported in thousands (i.e., a value of 1 corresponds to 1000 units of 512 bytes
read) and is rounded up. When the LBA size is a value other than 512 bytes, the
controller shall convert the amount of data read to 512 byte units.
For the NVM command set, logical blocks read as part of Compare and Read
operations shall be included in this value.
Data Units Written: Contains the number of 512 byte data units the host has
<b>Data Units Written:</b> Contains the number of 512 byte data units the host has written to the controller; this value does not include metadata. This value is
<b>Data Units Written:</b> Contains the number of 512 byte data units the host has written to the controller; this value does not include metadata. This value is reported in thousands (i.e., a value of 1 corresponds to 1000 units of 512 bytes
<b>Data Units Written:</b> Contains the number of 512 byte data units the host has written to the controller; this value does not include metadata. This value is
<b>Data Units Written:</b> Contains the number of 512 byte data units the host has written to the controller; this value does not include metadata. This value is reported in thousands (i.e., a value of 1 corresponds to 1000 units of 512 bytes
<b>Data Units Written:</b> Contains the number of 512 byte data units the host has written to the controller; this value does not include metadata. This value is reported in thousands (i.e., a value of 1 corresponds to 1000 units of 512 bytes written) and is rounded up. When the LBA size is a value other than 512 bytes,
<b>Data Units Written:</b> Contains the number of 512 byte data units the host has written to the controller; this value does not include metadata. This value is reported in thousands (i.e., a value of 1 corresponds to 1000 units of 512 bytes written) and is rounded up. When the LBA size is a value other than 512 bytes, the controller shall convert the amount of data written to 512 byte units.

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79:64	Host Read Commands: Contains the number of read commands completed by the controller.
	For the NVM command set, this is the number of Compare and Read commands.
95:80	Host Write Commands: Contains the number of write commands completed by the controller.
	For the NVM command set, this is the number of Write commands.
111:96	<b>Controller Busy Time:</b> Contains the amount of time the controller is busy with I/O commands. The controller is busy when there is a command outstanding to an I/O Queue (specifically, a command was issued via an I/O Submission Queue Tail doorbell write and the corresponding completion queue entry has not been posted yet to the associated I/O Completion Queue). This value is reported in minutes.
127:112	Power Cycles: Contains the number of power cycles.
143:128	<b>Power On Hours:</b> Contains the number of power-on hours. This may not include time that the controller was powered and in a non-operational power state.
159:144	<b>Unsafe Shutdowns:</b> Contains the number of unsafe shutdowns. This count is incremented when a shutdown notification (CC.SHN) is not received prior to loss of power.
175:160	<b>Media and Data Integrity Errors:</b> Contains the number of occurrences where the controller detected an unrecovered data integrity error. Errors such as uncorrectable ECC, CRC checksum failure, or LBA tag mismatch are included in this field.
191:176	Number of Error Information Log Entries: Contains the number of Error Information log entries over the life of the controller.
195:192	<b>Warning Composite Temperature Time:</b> Contains the amount of time in minutes that the controller is operational and the Composite Temperature is greater than or equal to the Warning Composite Temperature Threshold (WCTEMP) field and less than the Critical Composite Temperature Threshold (CCTEMP) field in the Identify Controller data structure.
	If the value of the WCTEMP or CCTEMP field is 0h, then this field is always cleared to 0h regardless of the Composite Temperature value.

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199:196	<ul> <li>Critical Composite Temperature Time: Contains the amount of time in minutes that the controller is operational and the Composite Temperature is greater than the Critical Composite Temperature Threshold (CCTEMP) field in the Identify Controller data structure.</li> <li>If the value of the CCTEMP field is 0h, then this field is always cleared to 0h regardless of the Composite Temperature value.</li> </ul>
201:200	<b>Temperature Sensor 1:</b> Contains the current temperature reported by temperature sensor 1.
203:202	<b>Temperature Sensor 2:</b> Contains the current temperature reported by temperature sensor 2.
205:204	<b>Temperature Sensor 3:</b> Contains the current temperature reported by temperature sensor 3.
207:206	<b>Temperature Sensor 4:</b> Contains the current temperature reported by temperature sensor 4.
209:208	<b>Temperature Sensor 5:</b> Contains the current temperature reported by temperature sensor 5.
211:210	<b>Temperature Sensor 6:</b> Contains the current temperature reported by temperature sensor 6.
213:212	<b>Temperature Sensor 7:</b> Contains the current temperature reported by temperature sensor 7.
215:214	<b>Temperature Sensor 8:</b> Contains the current temperature reported by temperature sensor 8.
219:216	<b>Thermal Management Temperature 1 Transition Count</b> : Contains the number of times the controller transitioned to lower power active power states or performed vendor specific thermal management actions while minimizing the impact on performance in order to attempt to reduce the Composite Temperature because of the host controlled thermal management feature (refer to section 8.4.5) (i.e., the Composite Temperature rose above the Thermal Management Temperature 1.) This counter shall not wrap once it reaches its maximum value. A value of zero, indicates that this transition has never occurred or this field is not implemented.
223:220	Thermal Management Temperature 2 Transition Count: Contains the number of times the controller transitioned to lower power active power states or performed vendor specific thermal management actions regardless of the

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	impact on performance (e.g., heavy throttling) in order to attempt to reduce the
	Composite Temperature because of the host controlled thermal management
	feature (refer to section 8.4.5) (i.e., the Composite Temperature rose above the
	Thermal Management Temperature 2.) This counter shall not wrap once it
	reaches its maximum value. A value of zero, indicates that this transition has
	never occurred or this field is not implemented.
	Total Time For Thermal Management Temperature 1: Contains the number
	of seconds that the controller had transitioned to lower power active power
	states or performed vendor specific thermal management actions while
227.224	minimizing the impact on performance in order to attempt to reduce the
227:224	Composite Temperature because of the host controlled thermal management
	feature (refer to section 8.4.5). This counter shall not wrap once it reaches its
	maximum value. A value of zero, indicates that this transition has never
	occurred or this field is not implemented.
	Total Time For Thermal Management Temperature 2: Contains the number
	of seconds that the controller had transitioned to lower power active power
	states or performed vendor specific thermal management actions regardless of
231:228	the impact on performance (e.g., heavy throttling) in order to attempt to reduce
231:228	the Composite Temperature because of the host controlled thermal management
	feature (refer to section 8.4.5). This counter shall not wrap once it reaches its
	maximum value. A value of zero, indicates that this transition has never
	occurred or this field is not implemented.
511:232	Reserved

The innodisk M.2 (P80) series thermal sensor take ambient air temperature as a reference with any airflow condition, and the data can refer to iSMART.

Notes: More detailed health info has been defined by innodisk and will be shown on iSMART V5.3.21 (or later version).

## 6. Part Number Rule

	1	2	3	4	5	6	7	8	9	10	11	12	13	14	15	16	17	18	19	20	21
CODE	D	G	м	2	8	-	0	1	т	D	С	1	к	С	в	Е	L	-	x	x	x
	Defini									tio	n										
Code 1 <sup>st</sup> (Disk)									Code 14 <sup>th</sup> (Operation Temperature)												
D : Disk							C	C: Standard Grade (0°C~ +70°C)													
Code 2 <sup>nd</sup> (Feature set)								١	W: Ir	ndust	rial	Grad	e (-4	۰℃°	~ +8	5°C)					
G : EverGreen Series																					
	C	Code	3rd	~5 <sup>th</sup>	' (Fo	rm f	acto	or)					Co	de 1	L5 <sup>th</sup>	(Int	erna	ıl co	ntro	I)	
M28: N	1.2 T	уре	2280	)-D2	-M						/	A~Z: BGA PCB version.									
		Cod	le 7'	<sup>th</sup> ~9	) <sup>th</sup> ((	Capa	city	)				Code 16 <sup>th</sup> (Channel of data transfer)									
A28: 1	28G	В	B5	6: 25	56GB		C12	: 51	2GB		[	D: Dual Channels									
01T: 1	ΤВ		02	T: 2T	В						(	Q: Quad Channels									
											I	E: Eight Channels									
	-		4 0 1		ath (	-		•						-		ath da		_	•		
					•	Cont	roll	er)				Code 17 <sup>th</sup> (Flash Type) L/Q: Innodisk 3D TLC									
DC1: P	Cle	3166	5-P S	eries	5							_/Q:	Inno	disk	3D	ILC					
	Code 13 <sup>th</sup> (Flash mode)									Code 18 <sup>th</sup> (Optional function)											
G: 3D	G: 3D TLC 96 Layer							ŀ	H: with heatsink accessory(for WT)												
K: 3D	K: 3D TLC 112 Layer																				
										Cod	le 1	9 <sup>th</sup> ^	, (Cı	istoi	mize	coc	le)				